

**EVLYS LTD. - POWER SEMICONDUCTORS DEVICES -**  
**Wholesale and Retail.**

**Phase Control Disc Thyristor Type DT24-500-8**

High power cycling capability / Low on-state and switching losses  
 Designed for traction and industrial applications

Mean on-state current	I <sub>TAV</sub>	500 A
Repetitive peak off-state voltage	V <sub>DRM</sub>	100 ÷ 800 V
Repetitive peak reverse voltage	V <sub>RRM</sub>	
Turn-off time	t <sub>q</sub>	80 µs
V <sub>DRM</sub> , V <sub>RRM</sub> , V	100      200      300      400      500      600      700      800	
Voltage code	1      2      3      4      5      6      7      8	
T <sub>j</sub> , °C		-60 ÷ 150

**MAXIMUM ALLOWABLE RATINGS**

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
I <sub>TAV</sub>	Mean on-state current	A	500 605	T <sub>c</sub> =100 °C, Double side cooled T <sub>c</sub> =85 °C, Double side cooled 180° half-sine wave; 50 Hz	
I <sub>TRMS</sub>	RMS on-state current	A	785	T <sub>c</sub> =100 °C, Double side cooled 180° half-sine wave; 50 Hz	
I <sub>TSM</sub>	Surge on-state current	kA	6.0 6.9	T <sub>j</sub> =T <sub>j max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; 50 Hz (t <sub>p</sub> =10 ms); single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs
			7.0 8.1	T <sub>j</sub> =T <sub>j max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; 60 Hz (t <sub>p</sub> =8.3 ms); single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs
I <sup>2</sup> t	Safety factor	A <sup>2</sup> s·10 <sup>3</sup>	180 235	T <sub>j</sub> =T <sub>j max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; 50 Hz (t <sub>p</sub> =10 ms); single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs
			200 270	T <sub>j</sub> =T <sub>j max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; 60 Hz (t <sub>p</sub> =8.3 ms); single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs
<b>BLOCKING</b>					
V <sub>DRM</sub> , V <sub>RRM</sub>	Repetitive peak off-state and Repetitive peak reverse voltages	V	100÷800	T <sub>j min</sub> < T <sub>j</sub> <T <sub>j max</sub> ; 180° half-sine wave; 50 Hz; Gate open	
V <sub>DSM</sub> , V <sub>RSM</sub>	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	200÷900	T <sub>j min</sub> < T <sub>j</sub> <T <sub>j max</sub> ; 180° half-sine wave; 50 Hz;single pulse; Gate open	
V <sub>D</sub> , V <sub>R</sub>	Direct off-state and Direct reverse voltages	V	0.75·V <sub>DRM</sub> 0.75·V <sub>RRM</sub>	T <sub>j</sub> =T <sub>j max</sub> ; Gate open	

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<b>TRIGGERING</b>				
I <sub>FGM</sub>	Peak forward gate current	A	5	T <sub>j</sub> =T <sub>j max</sub>
V <sub>RGM</sub>	Peak reverse gate voltage	V	5	
P <sub>G</sub>	Gate power dissipation	W	3	T <sub>j</sub> =T <sub>j max</sub> for DC gate current
<b>SWITCHING</b>				
(dI <sub>T</sub> /dt) <sub>crit</sub>	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/μs	250	T <sub>j</sub> =T <sub>j max</sub> ; V <sub>D</sub> =0.67·V <sub>DRM</sub> ; I <sub>TM</sub> =2 I <sub>TAV</sub> ; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 μs; dI <sub>G</sub> /dt≥1 A/μs
<b>THERMAL</b>				
T <sub>stg</sub>	Storage temperature	°C	-60÷150	
T <sub>j</sub>	Operating junction temperature	°C	-60÷150	
<b>MECHANICAL</b>				
F	Mounting force	kN	5.0÷7.0	
a	Acceleration	m/s <sup>2</sup>	50 100	Device unclamped Device clamped
<b>CHARACTERISTICS</b>				
Symbols and parameters		Units	Values	Conditions
<b>ON-STATE</b>				
V <sub>TM</sub>	Peak on-state voltage, max	V	1.55	T <sub>j</sub> =25 °C; I <sub>TM</sub> =1570 A
V <sub>T(TO)</sub>	On-state threshold voltage, max	V	0.80	T <sub>j</sub> =T <sub>j max</sub> ;
r <sub>T</sub>	On-state slope resistance, max	mΩ	0.490	0.5 π I <sub>TAV</sub> < I <sub>T</sub> < 1.5 π I <sub>TAV</sub>
I <sub>L</sub>	Latching current, max	mA	500	T <sub>j</sub> =25 °C; V <sub>D</sub> =12 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 μs; dI <sub>G</sub> /dt≥1 A/μs
I <sub>H</sub>	Holding current, max	mA	250	T <sub>j</sub> =25 °C; V <sub>D</sub> =12 V; Gate open
<b>BLOCKING</b>				
I <sub>DRM</sub> , I <sub>RRM</sub>	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	50	T <sub>j</sub> =T <sub>j max</sub> ; V <sub>D</sub> =V <sub>DRM</sub> ; V <sub>R</sub> =V <sub>RRM</sub>
(dv <sub>D</sub> /dt) <sub>crit</sub>	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/μs	1000	T <sub>j</sub> =T <sub>j max</sub> ; V <sub>D</sub> =0.67·V <sub>DRM</sub> ; Gate open
<b>TRIGGERING</b>				
V <sub>GT</sub>	Gate trigger direct voltage, max	V	4.00 2.50 2.00	T <sub>j</sub> = T <sub>j min</sub> T <sub>j</sub> =25 °C T <sub>j</sub> = T <sub>j max</sub>
I <sub>GT</sub>	Gate trigger direct current, max	mA	400 250 200	T <sub>j</sub> = T <sub>j min</sub> T <sub>j</sub> = 25 °C T <sub>j</sub> = T <sub>j max</sub>
V <sub>GD</sub>	Gate non-trigger direct voltage, min	V	0.25	T <sub>j</sub> =T <sub>j max</sub> ; V <sub>D</sub> =0.67·V <sub>DRM</sub> ;
I <sub>GD</sub>	Gate non-trigger direct current, min	mA	10.00	Direct gate current
<b>SWITCHING</b>				
t <sub>gd</sub>	Delay time	μs	1.60	T <sub>j</sub> =25 °C; V <sub>D</sub> =0.4·V <sub>DRM</sub> ; I <sub>TM</sub> =I <sub>TAV</sub> ; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 μs; dI <sub>G</sub> /dt≥1 A/μs
t <sub>q</sub>	Turn-off time <sup>2)</sup> , max	μs	80	dV <sub>D</sub> /dt=50 V/μs; T <sub>j</sub> =T <sub>j max</sub> ; I <sub>TM</sub> = I <sub>TAV</sub> ; di <sub>R</sub> /dt=-10 A/μs; V <sub>R</sub> =100V; V <sub>D</sub> =0.67·V <sub>DRM</sub>

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<b>THERMAL</b>					
$R_{thjc}$	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.070	Direct current	Double side cooled
$R_{thjc-A}$			0.154		Anode side cooled
$R_{thjc-K}$			0.126		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.010	Direct current	

<b>MECHANICAL</b>					
W	Weight, typ	g	70		
$D_s$	Surface creepage distance	mm (inch)	7.94 (0.313)		
$D_a$	Air strike distance	mm (inch)	5.00 (0.197)		

### PART NUMBERING GUIDE

DT  
 24  
 500  
 8  
 1      2      3      4

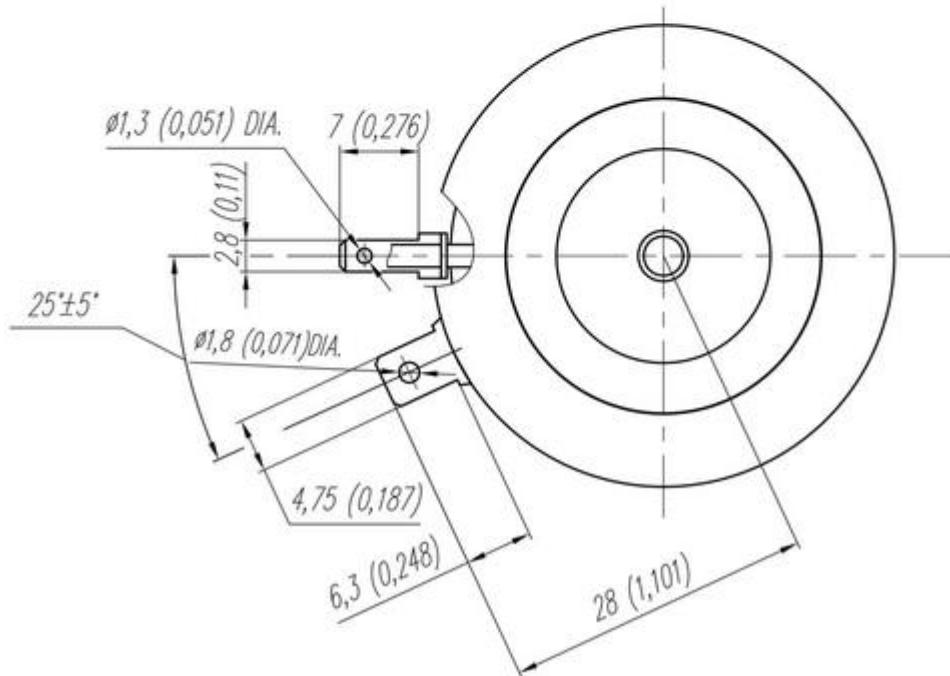
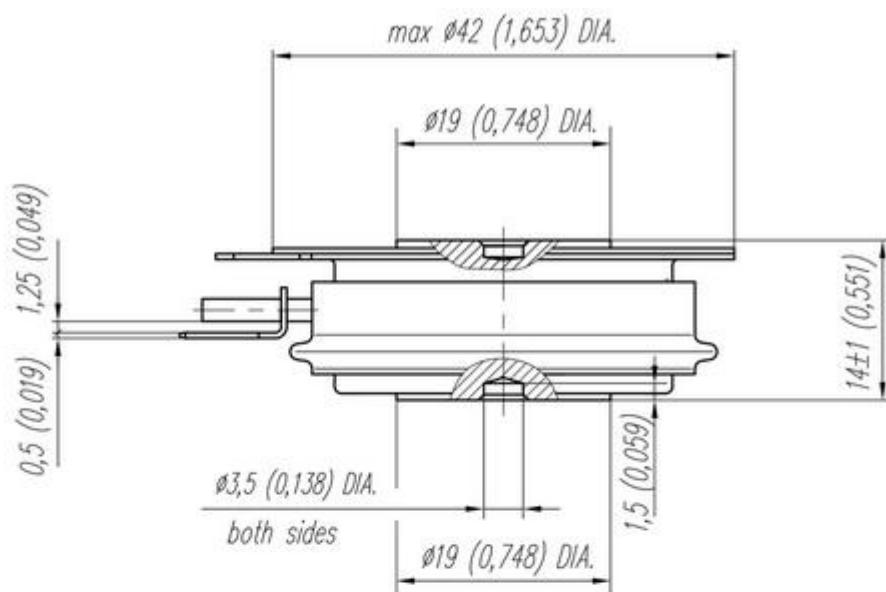
1. DT - Phase Control Disc Thyristor
2. Element Diameter
3. Mean on-state current, A
4. Voltage code

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### **OVERALL DIMENSIONS**

**Package type: T.A1**



All dimensions in millimeters (inches)